IRF730B



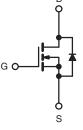
Vishay Siliconix

D Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	450			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	1.0		
Q _g max. (nC)	18			
Q _{gs} (nC)	3			
Q _{gd} (nC)	4			
Configuration	Single			

TO-220AB





N-Channel MOSFET

FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Consumer Electronics
- Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies

 SMPS
- Industrial
 - Welding
 - weiding
 - Induction Heating
- Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF730BPbF

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	400			
Gate-Source Voltage		V _{GS}	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	30				
Continuous Drain Current (T, = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$	I _D	6		
Continuous Drain Current (1j = 150°C)	V_{GS} at 10 V $T_C = 100 \text{ °C}$		4	А	
Pulsed Drain Current ^a		I _{DM}	13		
Linear Derating Factor			0.8	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	104	mJ	
Maximum Power Dissipation		PD	104	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	25 °C dV/dt 24		V/ns	
Reverse Diode dV/dt ^d		uv/ul	0.48		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^c	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 9.5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,$ starting T_J = 25 °C.

S12-1392-Rev. A, 18-Jun-12

COMPLIANT

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.2			°C/W			
SPECIFICATIONS (T _{.1} = 25 $^{\circ}$ C, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	,	T CONDITION	S	MIN.	TYP.	MAX.	UNIT
Static					I			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250	μA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		to 25 °C, I _D =		-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250	μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	-	$V_{GS} = \pm 30 \text{ V}$	•	-	-	± 100	nA
			= 400 V, V _{GS} =	0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$ $I_D = 3 A$		-	0.85	1.0	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 3 A		-	1.7	-	S	
Dynamic					•	•		
Input Capacitance	C _{iss}	V _{GS} = 0 V,			-	311	-	pF
Output Capacitance	C _{oss}	$V_{DS} = 0.0$ V, $V_{DS} = 100$ V, f = 1 MHz		-	38	-		
Reverse Transfer Capacitance	C _{rss}			-	7	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	44	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	54	-		
Total Gate Charge	Qg				-	9	18	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$	I _D = 3 A, V	_{DS} = 320 V	-	3	-	
Gate-Drain Charge	Q _{gd}				-	4	-	1
Turn-On Delay Time	t _{d(on)}				-	12	24	
Rise Time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 400 \; \text{V}, \; I_{\text{D}} = 3 \; \text{A}, \\ V_{\text{GS}} = 10 \; \text{V}, \; R_{g} = 9.1 \; \Omega \end{array}$		-	11	22	ns	
Turn-Off Delay Time	t _{d(off)}			-	14	28		
Fall Time	t _f			-	8	16		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.9	-	Ω	
Drain-Source Body Diode Characteristi								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6	А	
Pulsed Diode Forward Current	I _{SM}			-	-	24		
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 3 A, V _G	_S = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}				-	236	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$		-	1.1	-	μC	
Reverse Recovery Current	I _{RRM}	ui/ut =	dl/dt = 100 A/µs, V _R = 20 V		-	9	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

Document Number: 91518



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

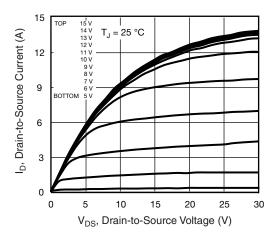


Fig. 1 - Typical Output Characteristics

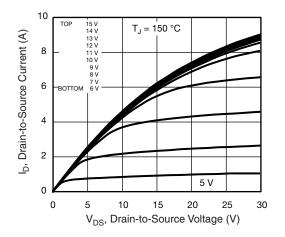


Fig. 2 - Typical Output Characteristics

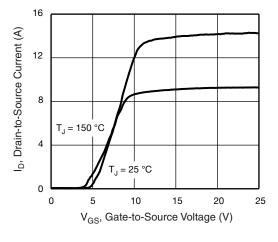


Fig. 3 - Typical Transfer Characteristics

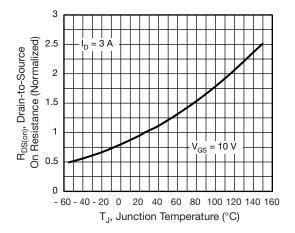


Fig. 4 - Normalized On-Resistance vs. Temperature

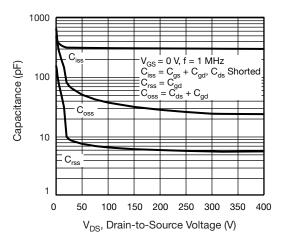


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

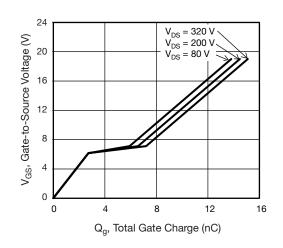
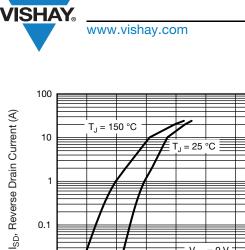


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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IRF730B

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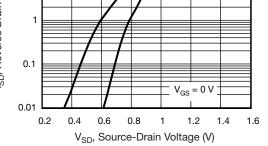


Fig. 7 - Typical Source-Drain Diode Forward Voltage

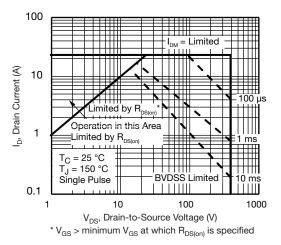


Fig. 8 - Maximum Safe Operating Area

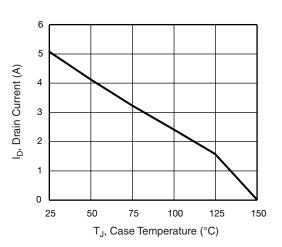


Fig. 9 - Maximum Drain Current vs. Case Temperature

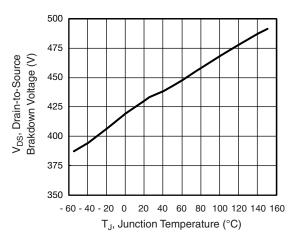


Fig. 10 - Temperature vs. Drain-to-Source Voltage

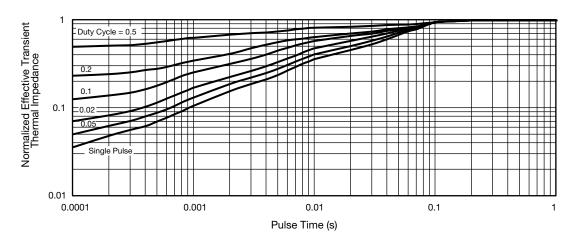
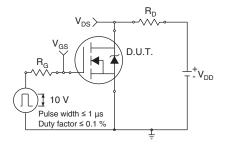


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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Fig. 12 - Switching Time Test Circuit

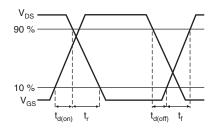


Fig. 13 - Switching Time Waveforms

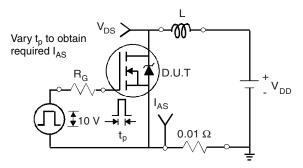


Fig. 14 - Unclamped Inductive Test Circuit

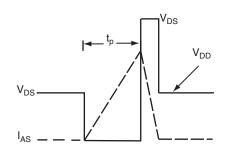


Fig. 15 - Unclamped Inductive Waveforms

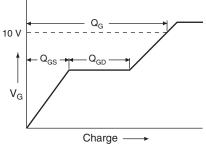


Fig. 16 - Basic Gate Charge Waveform

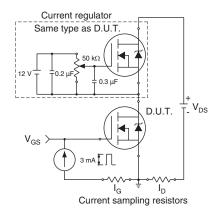


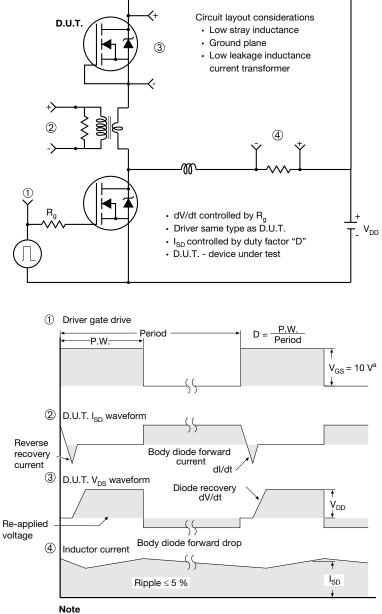
Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INCHES	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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